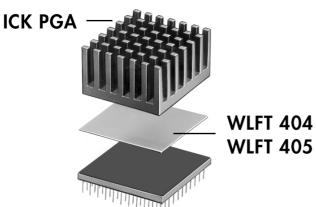
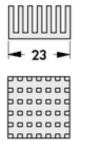
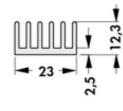
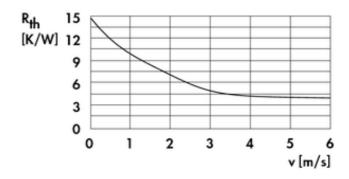
Details 23.11.10 08:31

## Heatsinks for PGA / ICK PGA 8 x 8 x 12









23 x 23 x 12,3 mm, for IC design PGA and others

## Parameters of article ICK PGA 8 x 8 x 12

**mounting method** therm. conductive foil / therm. cond. adhesive

socketuniversalsuitable for processor typeuniversal

width [mm]23heigth [mm]12.3plate thickness [mm]2.5length on stock [mm]23

**surface treatment** black anodised

## Accessories/ related articles

Thermally conductive foil both sides adhesive / WLFT 404 23  $\times$  23 Thermally conductive foil both sides adhesive / WLFT 405 23  $\times$  23

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